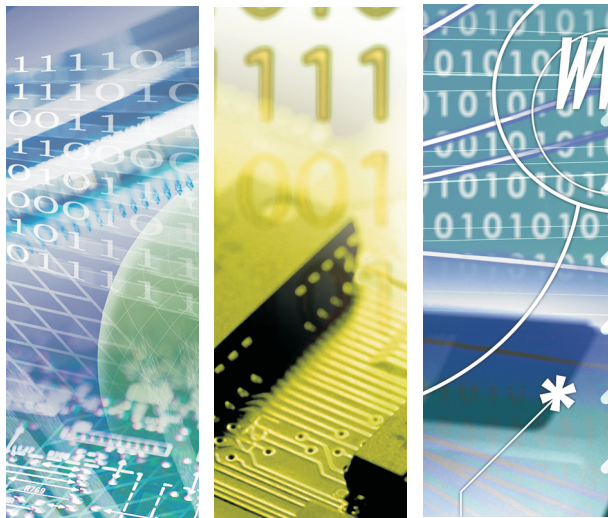




MUB419Q

HSDPA Unlocked USB Modem



MUB419Q

Bointec MUB419 HSDPA Unlocked USB Modem

Introduction to Products



Features

- Chipset Qualcomm 6280
- Zero-CD (No need CD-ROM)
- Support System 32/64 Bit:
Win2000/XO/Vista/Win7/Android
- Support Mac OS X 10.4 or later
- Auto Install Driver
- Support T-Flash memory extension, 32GB in max
- Interface: Standard USB 2.0 high speed
- Operating temperature:-20~55°C
- Storage Temperature:-25~70 °C
- RoHS compliant

Specification	
Network Type	WCDMA
Chipset	Qualcomm 6280
Transmission	HSDPA,UMTS/WCDMA EDGE,GPRS,GSM network compatible
	HSDPA 7.2Mbps downlink and 384Kbps uplink rate in max
	UMTS(PS) 384Kbps downlink and uplink rate
	EDGE 384Kbps downlink and 177Kbps uplink rat in max
	GPRS/GSM 115.2Kbps downlink and 5.76Kbps uplink rate in max
Frequency Scope	GSM/GPRS/EDGE 850/900/1800/1900MHz
	UMTS 2100MHz
Support System	32/64Bit: Win2000/XP/Vista/Win7/Android
	Mac OS X 10.4 or later
Drive	Zero-CD (No need CD-ROM)
Installation	Auto Install Driver
Memory Extension	Support T-Flash memory extension, 32GB in max
SMS	Save in SIM Card or PC
	New, Delete, Transfer SMS, Reply, Extract, Archive
Phonebook	Save in SIM Card or PC
	New, Edit, Delete, Group, Search, Transfer, Dial
Statistics	Total traffic, Downlink and uplink rate
Settings	PIN, Text, Network, Profiles, Preference
	APN auto management
Languages	English. Optional other languages for OEM
Antenna	Inside 3G&GSM antenna or External Antenna (MMCX connector)
Interface	Standard USB 2.0 high speed
Power Supply	5vdc Powered via the USB interface
Working current	Max500mA
Temperature	Operating temperature: -20~55°C, Storage Temperature: -25~70°C
Susceptiveness	<-104dBm
Humidity	<=93%
Dimensions	W803: 90(D)x29(W)x10(H)mm/19g
	W805: 90(D)x27(W)x11(H)mm/18g



We are Your Partner more than Business



TAIJET BOINTEC CO LTD
 4F, #114, ZHOULI ST., NEIHU-TAIPEI 11493, TAIWAN
 TEL: +886-2-2759-0081 EMAIL: contact@bointec.com
 WWW.BOINTEC.COM



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